

TOSHIBA PHOTOCOUPLER GaAs IRED & PHOTO-TRIAC

## TLP3051F(S),TLP3052F(S)

## OFFICE MACHINE HOUSEHOLD USE EQUIPMENT TRIAC DRIVERSOLID STATE RELAY

The TOSHIBA TLP3051F(S) and TLP3052F(S) consists of a photo-triac optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP packge.

All parameters are tested to the specification of TLP3051(S),TLP3052(S). (both condition and limits)

Peak Off-State Voltage : 600V(Min)

Trigger LED Current : 15mA(Max)TLP3051

10mA(Max)TLP3052

On-State Current : 100mA(Max)
 Isolation Voltage : 5000Vrms(Min)

• UL Recognized :UL1577,File No.E67349

SEMKO Approved :SS EN60065, File No.9841102
 SS EN60950, File No.9841102

:BS EN60065, File No.8385

BS EN60950, File No.8386

Option(D4)type

**BSI** Approved

VDE Approved :DIN VDE0884

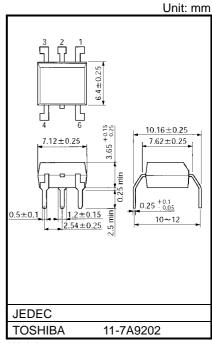
Certificate No.68383

Maximum Operating Insulation Voltage : 1140V<sub>PK</sub>
 Highest Permissible Over Voltage :8000 V<sub>PK</sub>

(Note)When a VDE0884 approved type is needed, please designate the "Option(D4)"

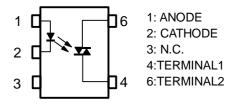
Construction Mechanical Rating(10.16mm pich)

Creepage Distance : 8.0mm(Min)
Clearance : 8.0mm(Min)
Insulation Thickness : 0.5mm(Min)



Weight: 0.39 g

## **PIN CONFIGURATION (TOP VIEW)**



## **RESTRICTIONS ON PRODUCT USE**

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- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
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